Available @

Notes
Syllabus
Question Papers
Results and Many more...

www.AllAbtEngg.com

EE8091 MICRO ELECTRO MECHANICAL SYSTEMS VANCED I.C ENGINES

DETAILED SYLLABUS

OBJECTIVES

- To provide knowledge of semiconductors and solid mechanics to fabricate MEMS devices.
- To educate on the rudiments of Micro fabrication techniques.
- To introduce various sensors and actuators
- To introduce different materials used for MEMS
- To educate on the applications of MEMS to disciplines beyond Electrical and Mechanical engineering.

UNIT I INTRODUCTION

Intrinsic Characteristics of MEMS – Energy Domains and Transducers- Sensors and Actuators – Introduction to Micro fabrication - Silicon based MEMS processes – New Materials – Review of Electrical and Mechanical concepts in MEMS – Semiconductor devices – Stress and strain analysis – Flexural beam bending- Torsional deflection.

UNIT II SENSORS AND ACTUATORS-I

Electrostatic sensors – Parallel plate capacitors – Applications – Interdigitated Finger capacitor – Comb drive devices – Micro Grippers – Micro Motors - Thermal Sensing and Actuation – Thermal expansion – Thermal couples – Thermal resistors – Thermal Bimorph - Applications – Magnetic Actuators – Micromagnetic components – Case studies of MEMS in magnetic actuators- Actuation using Shape Memory Alloys

UNIT III SENSORS AND ACTUATORS-II

Piezoresistive sensors – Piezoresistive sensor materials - Stress analysis of mechanical elements – Applications to Inertia, Pressure, Tactile and Flow sensors – Piezoelectric sensors and actuators – piezoelectric effects – piezoelectric materials – Applications to Inertia, Acoustic, Tactile and Flow sensors.

UNIT IV MICROMACHINING

Silicon Anisotropic Etching – Anisotrophic Wet Etching – Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE) – Isotropic Wet Etching – Gas Phase Etchants – Case studies - Basic surface micro machining processes – Structural and Sacrificial Materials – Acceleration of sacrificial Etch – Striction and Antistriction methods – LIGA Process - Assembly of 3D MEMS – Foundry process.

UNIT V POLYMER AND OPTICAL MEMS

Polymers in MEMS- Polimide - SU-8 - Liquid Crystal Polymer (LCP) - PDMS - PMMA - Parylene - Fluorocarbon - Application to Acceleration, Pressure, Flow and Tactile sensors-Optical MEMS - Lenses and Mirrors - Actuators for Active Optical MEMS.

Diploma, Anna Univ UG & PG Courses

Notes
Syllabus
Question Papers
Results and Many more...

Available @

www.AllAbtEngg.com

TEXT BOOKS:

- 1. Chang Liu, "Foundations of MEMS", Pearson Education Inc., 2006.
- 2. Stephen D Senturia, "Microsystem Design", Springer Publication, 2000.
- 3. Tai Ran Hsu, "MEMS & Micro systems Design and Manufacture" Tata McGraw Hill, New Delhi, 2002.

REFERENCES:

- 1. James J. Allen, "Micro Electro Mechanical System Design", CRC Press Publisher, 2010
- 2. Julian w. Gardner, Vijay K. Varadan, Osama O. Awadelkarim, "Micro Sensors MEMS and Smart Devices", John Wiley & Son LTD,2002
- 3. Mohamed Gad-el-Hak, editor, "The MEMS Handbook", CRC press Baco Raton, 2000
- 4. Nadim Maluf, "An Introduction to Micro Electro Mechanical System Design", Artech House, 2000.
- 5. Thomas M. Adams and Richard A. Layton, "Introduction MEMS, Fabrication and Application," Springer 2012.